

Alloy Designation

EN	Cu-OF
DIN CEN/TS 13388	CW008A
UNS	C10200

Chemical Composition (Balance)

Weight percentage

Cu	≥ 99.95	%
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Mechanical Properties (EN 1652)

Temper	Tensile Strength	Yield Strength Minimum	Elongation Minimum	Hardness	Bending 90°	
	Rm	Rp0.2	A <sub>50mm</sub>	HV *	gw rel. Bending Radius R/T	bw
	MPa	MPa	%	HV	Strip Thickness ≤ 0.50mm	
R220	220 .. 260	≤ 140 *	33	40 .. 65	0	0
R240	240 .. 300	180	8	65 .. 95	0	0
R290	290 .. 360	250	4	90 .. 110	0	0
R360	≥ 360	320	2	≥ 110	0	0.5

\* only for information

Physical Properties

Typical values in annealed temper at 20 °C

Density		8.93	g/cm <sup>3</sup>
Thermal expansion coefficient	20 .. 300 °C	17.7	10 <sup>-6</sup> /K
Specific heat capacity		0.39	J/(g·K)
Thermal conductivity		394	W/(m·K)
Electrical conductivity	MS/m	58	MS/m
Electrical conductivity	IACS	100	%
Thermal coefficient of electrical resistance	(0 .. 100 °C)	3.81	10 <sup>-3</sup> /K
Modulus of elasticity	GPa	130	GPa

Due to continuous improvements within our production process, the details given in our brochure cannot be guaranteed. We reserve the right to update or change our products without prior notice. We recommend that you seek confirmation of our product details / specifications before committing to specific alloys.

Characteristics

**Cu-OF** is a high purity, oxygen free, non phosphorus-deoxidized copper that does not contain in vacuum evaporating elements. It has a very high electrical and thermal conductivity, good welding and excellent soldering properties. It has excellent hot and cold forming properties, and a good corrosion resistance, especially in atmosphere due to a good adherence of the oxide layer.

Main Applications

**Automotive:** Automotive Rectifiers  
**Electrical:** Transistor Component Bases, High Resistance-Ratio Cryogenic Shunts, Bus Conductors, Wave Guides, Hollow Conductors, Anodes for Vacuum Tubes, Coaxial Cable, Waveguides, High Frequency Cable, Submarine Cable, Coaxial Tube, Klystrons, Microwave Tubes, Bus Bars, Lead-in Wire, Vacuum Seals, Conductors, Glass-to-Metal Seals, Lead frames for semiconductors, Heat sinks.

Fabrication Properties \*

Cold Forming Properties	Excellent
Machinability (Rating 20)	Less suitable
Electroplating Properties	Excellent
Hot Tinning Properties	Excellent
Soft Soldering, Brazing	Excellent
Resistance Welding	Less suitable
Gas Shielded Arc Welding	Excellent
Laser Welding	Fair

\* For more details call our technical service